

**AMENDMENT****Amendment(s) to the Specification**

Please replace the paragraph [0021] at page 7, lines 3-20 with the following amended paragraph:

[0021] The drive cooling baffle 30 is configured to generally enclose the fans and the electronics devices within a volume generally define by the baffle 30, by the electronics components base 12 and by the fans. The drive cooling baffle 30 defines an inflow opening 32 and an outflow opening 34 to allow the fans to direct airflow therebetween. In one example, two fans are provided as the inflow fans 20 while only one fan is provided as the outflow fan 22. Such a configuration may allow the generation of a positive air pressure within the volume enclosed by the drive cooling baffle 30 to further facilitate cooling of the electronics components by ensuring sufficient cool ambient air being drawn into the volume enclosed by the drive cooling baffle 30. The provision of an outflow fan 22 helps to reduce or otherwise overcome the effect of leaks in the volume enclosed by the drive cooling baffle 30. Any suitable number and configuration of inflow and/or outflow fans may be provided. It is noted that a positive air pressure within the volume defined by the baffle may be achieved in other manners. For example, a single inflow fan with greater air movement capabilities (e.g., higher cubic feet per minute (CFM)) may be provided in conjunction with a single outflow fan with a lower air movement capabilities. As seen in FIG. [[3]] 4, the drive cooling baffle 30 also defines openings 36 for various wiring or other cabling connected to the electronics components to pass therethrough.